74AHC1G4214-Q100

14-stage divider and oscillator

Rev. 2 — 13 January 2022

Product data sheet

1. General description

74AHC1G4214-Q100 is a 14-stage divider and oscillator. It consists of a chain of 14 flip-flops. Each flip-flop divides the frequency of the previous flip-flop by two, consequently the 74AHC1G4214-Q100 counts up to 2¹⁴ = 16384. The single inverting stage (X1 to X2) functions as a crystal oscillator or an input buffer for an external oscillator. When used as a buffer the output X2 should be left floating. The frequency of the output (Q) is the frequency applied to X1 divided by 16384. The divider advances on the negative-going transition of X1.

The X1 input is overvoltage tolerant. This feature allows the use of this device as a voltage level translator in mixed voltage environments.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F: exceeds 2000 V
 - CDM JESD22-C101E: exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II

3. Ordering information

Table 1. Ordering information

Type number Package							
	Temperature range	Name	Description	Version			
74AHC1G4214GW-Q100	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1			

4. Marking

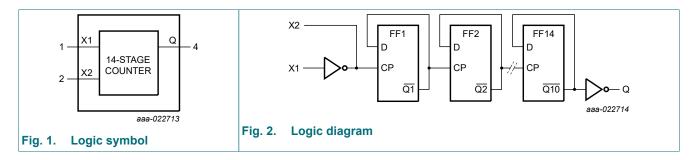
Table 2. Marking codes

Type number	Marking[1]
74AHC1G4214GW-Q100	C4

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

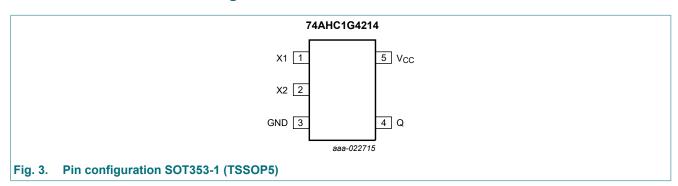


5. Functional diagram



6. Pinning information

6.1. Pinning

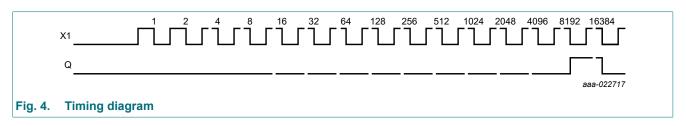


6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
X1	1	clock input/oscillator pin
X2	2	oscillator pin
GND	3	ground (0 V)
Q	4	divider output
Vcc	5	supply voltage

7. Functional description



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8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	-20	-	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I _O	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	75	mA
I _{GND}	ground current		-75	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ [2]	-	250	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall	V _{CC} = 3.3 V ± 0.3 V	-	-	100	ns/V
	rate	V _{CC} = 5.0 V ± 0.5 V	-	-	20	ns/V

^[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.

10. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	bol Parameter Conditions			25 °C		-40 °C	to +85 °C	-40 °C to +125 °C		Unit	
				Min	Тур	Max	Min	Max	Min	Max	1
V _{IH}	HIGH-level	X1									
	input voltage	V _{CC} = 2.0 V	1.7	-	-	1.7	-	1.7	-	V	
		V _{CC} = 3.0 V	2.4	-	-	2.4	-	2.4	-	V	
		V _{CC} = 5.5 V	4.4	-	-	4.4	-	4.4	-	V	
V _{IL}	LOW-level	X1									
	input voltage	V _{CC} = 2.0 V	-	-	0.3	-	0.3	-	0.3	V	
		V _{CC} = 3.0 V	-	-	0.6	-	0.6	-	0.6	V	
		V _{CC} = 5.5 V	-	-	1.1	-	1.1	-	1.1	V	
V _{OH}	HIGH-level	$Q; V_I = V_{IH} \text{ or } V_{IL}$									
	output voltage	I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V	
		I _O = -50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V	
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V	
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V	
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.94	-	-	3.8	-	3.70	-	V	
		$X2; V_I = V_{IH} \text{ or } V_{IL}$									
		I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V	
		I _O = -50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V	
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V	
		I _O = -2.0 mA; V _{CC} = 3.0 V	2.58	-	-	2.48	-	2.40	-	V	
		$I_O = -3.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V	
V _{OL}	LOW-level	Q; $V_I = V_{IH}$ or V_{IL}									
	output voltage	I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V	
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V	
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V	
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V	
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V	
		$X2; V_I = V_{IH} \text{ or } V_{IL}$									
		I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V	
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V	
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V	
		I _O = 2.0 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V	
		I _O = 3.0 mA; V _{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V	
lį	input leakage current	X1; V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ	
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	1.0	-	10	-	40	μA	
C _I	input capacitance	X1	-	3	8	-	8	-	8	pF	

11. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; $t_r = t_f = \le 3.0$ ns. For test circuit see Fig. 7. For waveforms see Fig. 5 and Fig. 6.

Symbol	Parameter	Conditions			25 °C		-40 °C	to +85 °C	-40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	1
t _{pd}	propagation	X1 to X2	[1]								
	delay	V _{CC} = 3.0 V to 3.6 V	[2]								
		C _L = 15 pF		-	3	7	1	11	1	13	ns
		C _L = 50 pF		-	7	13	1	16	1	18	ns
		V _{CC} = 4.5 V to 5.5 V	[3]								
		C _L = 15 pF		-	2	5	1	7	1	9	ns
		C _L = 50 pF		-	6	10	1	11	1	12	ns
		X1 to Q	[1]								
		V _{CC} = 3.0 V to 3.6 V	[2]								
		C _L = 15 pF		-	33	55	1	67	1	78	ns
		C _L = 50 pF		-	35	60	1	71	1	82	ns
		V _{CC} = 4.5 V to 5.5 V	[3]								
		C _L = 15 pF		-	23	36	1	44	1	52	ns
		C _L = 50 pF		-	25	40	1	51	1	58	ns
t _W	pulse width	X1 HIGH or LOW									
		V _{CC} = 3.0 V to 3.6 V		4	-	-	5	-	7	-	ns
		V _{CC} = 4.5 V to 5.5 V		3	-	-	4	-	5	-	ns
f _{max}	maximum	X1									
	frequency	V _{CC} = 3.3 V		125	-	-	100	-	70	-	MHz
		V _{CC} = 5 V		165	-	-	125	-	100	-	MHz
C _{PD}	power dissipation	C_L = 50 pF; f_i = 1 MHz; V_I = GND to V_{CC}	[4]								
	capacitance	V _{CC} = 3.3 V		-	4	-	-	-	-	-	pF
		V _{CC} = 5 V		-	5	-	-	-	-	-	рF

 f_i = input frequency in MHz; C_L = output load capacitance in pF; V_{CC} = supply voltage in Volt.

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 t_{pd} is the same as t_{PLH} and t_{PHL} . Typical values are measured at V_{CC} = 3.3 V. Typical values are measured at V_{CC} = 5.0 V. C_{PD} is used to determine the dynamic power dissipation P_D (µW). P_D = C_{PD} x V_{CC}^2 x f_i + C_L x V_{CC}^2 x f_i / 16384 where:

11.1. Waveforms and test circuit

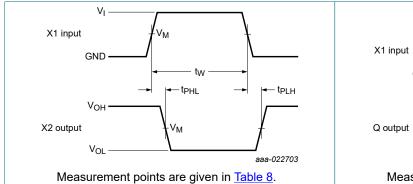
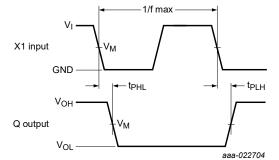


Fig. 5. Input X1 to output X2 propagation delay times

occur with the output load.

 V_{OL} and V_{OH} are typical output voltage levels that



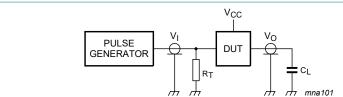
Measurement points are given in <u>Table 8</u>.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 6. Input X1 to output Q propagation delay times

Table 8. Measurement points

Inputs	Output	
V _I	V _M	V _M
GND to V _{CC}	0.5 x V _{CC}	0.5 x V _{CC}



Test data is given in <u>Table 7</u>. Definitions for test circuit:

C_L = Load capacitance including jig and probe capacitance.

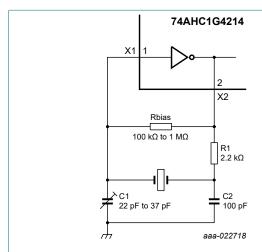
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig. 7. Test circuit for measuring switching times

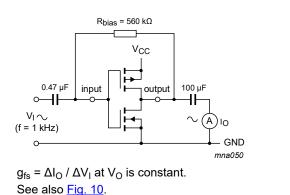
12. Crystal oscillator

12.1. Typical crystal oscillator circuit

A typical crystal oscillator schematic is shown in Fig. 8. R1 is the power limiting resistor, its value depends on the frequency and required stability against changes in V_{CC} or average I_{CC}. For starting and maintaining oscillation a minimum transconductance is necessary, so R1 should not be too large. A practical value for R1 is $2.2 \text{ k}\Omega$.

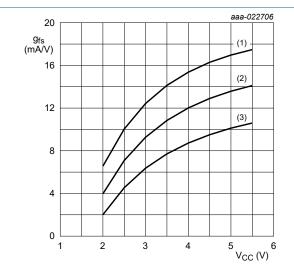


External component connection for a crystal Fig. 8. oscillator



Test set-up for measuring forward





 T_{amb} = 25 °C.

- (1) Maximum.
- (2) Typical.
- (3) Minimum.

Fig. 10. Typical forward transconductance as function of the supply voltage

13. Package outline

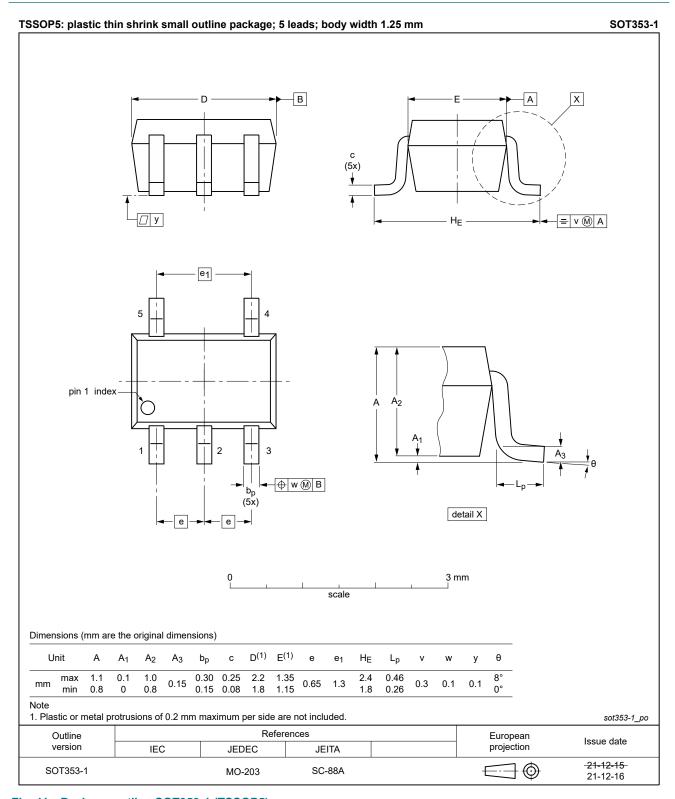


Fig. 11. Package outline SOT353-1 (TSSOP5)

14. Abbreviations

Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military

15. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74AHC1G4214_Q100 v.2	20220113	Product data sheet	-	74AHC1G4214_Q100 v.1			
Modifications:	 <u>Section 8</u>: Derating values for P_{tot} total power dissipation updated. <u>Fig. 11</u>: Package outline drawing SOT353-1 (TSSOP5) updated. 						
74AHC1G4214_Q100 v.1	20190208	Product data sheet	-	-			

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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